

# PDTA144E series

PNP resistor-equipped transistors;  
R1 = 47 k $\Omega$ , R2 = 47 k $\Omega$

Rev. 8 — 14 November 2011

Product data sheet

## 1. Product profile

### 1.1 General description

PNP Resistor-Equipped Transistor (RET) family in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

| Type number | Package  |        |          | NPN complement | Package configuration |
|-------------|----------|--------|----------|----------------|-----------------------|
|             | Nexperia | JEITA  | JEDEC    |                |                       |
| PDTA144EE   | SOT416   | SC-75  | -        | PDTC144EE      | ultra small           |
| PDTA144EM   | SOT883   | SC-101 | -        | PDTC144EM      | leadless ultra small  |
| PDTA144ET   | SOT23    | -      | TO-236AB | PDTC144ET      | small                 |
| PDTA144EU   | SOT323   | SC-70  | -        | PDTC144EU      | very small            |

### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

### 1.3 Applications

- Digital applications in automotive and industrial segments
- Control of IC inputs
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

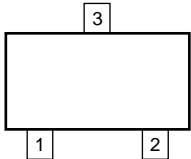
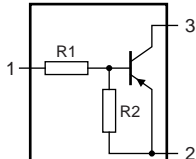
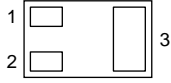
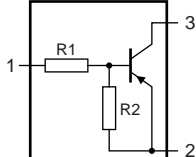
### 1.4 Quick reference data

Table 2. Quick reference data

| Symbol           | Parameter                 | Conditions | Min | Typ | Max  | Unit       |
|------------------|---------------------------|------------|-----|-----|------|------------|
| V <sub>CEO</sub> | collector-emitter voltage | open base  | -   | -   | -50  | V          |
| I <sub>O</sub>   | output current            |            | -   | -   | -100 | mA         |
| R1               | bias resistor 1 (input)   |            | 33  | 47  | 61   | k $\Omega$ |
| R2/R1            | bias resistor ratio       |            | 0.8 | 1   | 1.2  |            |

## 2. Pinning information

Table 3. Pinning

| Pin                          | Description        | Simplified outline  | Graphic symbol  |
|------------------------------|--------------------|---|---|
| <b>SOT23; SOT323; SOT416</b> |                    |   |   |
| 1                            | input (base)       | <br>006aaa144            | <br>sym003 |
| 2                            | GND (emitter)      |   |   |
| 3                            | output (collector) |   |   |
| <b>SOT883</b>                |                    |   |   |
| 1                            | input (base)       | <br>Transparent top view | <br>sym003 |
| 2                            | GND (emitter)      |   |   |
| 3                            | output (collector) |   |   |

## 3. Ordering information

Table 4. Ordering information

| Type number | Package |   |         |
|-------------|---------|---|---------|
|             | Name    | Description   | Version |
| PDTA144EE   | SC-75   | plastic surface-mounted package; 3 leads                                      | SOT416  |
| PDTA144EM   | SC-101  | leadless ultra small plastic package; 3 solder lands; body 1.0 × 0.6 × 0.5 mm | SOT883  |
| PDTA144ET   | -       | plastic surface-mounted package; 3 leads                                      | SOT23   |
| PDTA144EU   | SC-70   | plastic surface-mounted package; 3 leads                                      | SOT323  |

## 4. Marking

Table 5. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PDTA144EE   | 07                          |
| PDTA144EM   | DR                          |
| PDTA144ET   | *07                         |
| PDTA144EU   | *07                         |

[1] \* = placeholder for manufacturing site code

## 5. Limiting values

**Table 6. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol           | Parameter                 | Conditions                             | Min    | Max  | Unit |    |
|------------------|---------------------------|--|--------|------|------|----|
| V <sub>CBO</sub> | collector-base voltage    | open emitter                           | -      | -50  | V    |    |
| V <sub>CEO</sub> | collector-emitter voltage | open base                              | -      | -50  | V    |    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector                         | -      | -10  | V    |    |
| V <sub>I</sub>   | input voltage             |  |        |      |      |    |
|                  | positive                  |  | -      | +10  | V    |    |
|                  | negative                  |  | -      | -40  | V    |    |
| I <sub>O</sub>   | output current            |  | -      | -100 | mA   |    |
| I <sub>CM</sub>  | peak collector current    | single pulse;<br>t <sub>p</sub> ≤ 1 ms | -      | -100 | mA   |    |
| P <sub>tot</sub> | total power dissipation   | T <sub>amb</sub> ≤ 25 °C               |        |      |      |    |
|                  | PDTA144EE (SOT416)        |  | [1][2] | -    | 150  | mW |
|                  | PDTA144EM (SOT883)        |  | [2][3] | -    | 250  | mW |
|                  | PDTA144ET (SOT23)         |  | [1]    | -    | 250  | mW |
|                  | PDTA144EU (SOT323)        |  | [1]    | -    | 200  | mW |
| T <sub>j</sub>   | junction temperature      |  | -      | 150  | °C   |    |
| T <sub>amb</sub> | ambient temperature       |  | -65    | +150 | °C   |    |
| T <sub>stg</sub> | storage temperature       |  | -65    | +150 | °C   |    |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70  $\mu$ m copper strip line, standard footprint.



## 6. Thermal characteristics

**Table 7. Thermal characteristics**

| Symbol        | Parameter                                   | Conditions  | Min | Typ | Max | Unit |
|---------------|---|-------------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air |     |     |     |      |
|               | PDTA144EE (SOT416)                          | [1][2]      | -   | -   | 830 | K/W  |
|               | PDTA144EM (SOT883)                          | [2][3]      | -   | -   | 500 | K/W  |
|               | PDTA144ET (SOT23)                           | [1]         | -   | -   | 500 | K/W  |
|               | PDTA144EU (SOT323)                          | [1]         | -   | -   | 625 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 μm copper strip line, standard footprint.



FR4 PCB, standard footprint

**Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA144EE (SOT416); typical values**



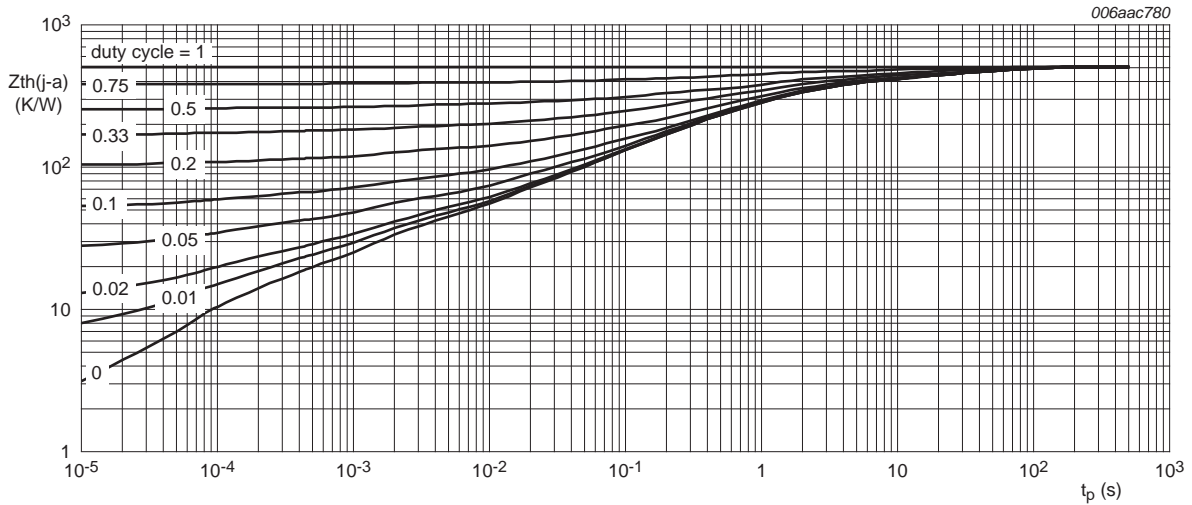
FR4 PCB, 70 μm copper strip line

**Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA144EM (SOT883); typical values**



FR4 PCB, standard footprint

**Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA144ET (SOT23); typical values**



FR4 PCB, standard footprint

**Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration for PDTA144EU (SOT323); typical values**

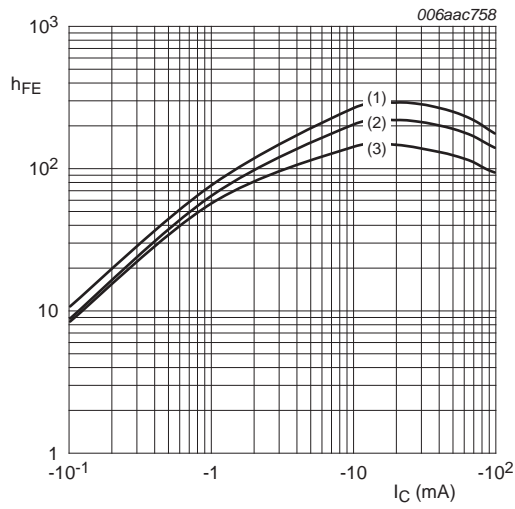
## 7. Characteristics

**Table 8. Characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

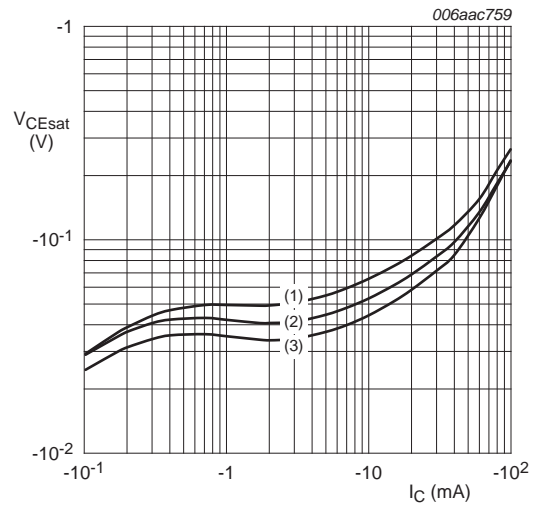
| Symbol       | Parameter                            | Conditions   | Min | Typ  | Max  | Unit          |
|--------------|--------------------------------------|--|-----|------|------|---------------|
| $I_{CBO}$    | collector-base cut-off current       | $V_{CB} = -50\text{ V}$ ; $I_E = 0\text{ A}$   | -   | -    | -100 | nA            |
| $I_{CEO}$    | collector-emitter cut-off current    | $V_{CE} = -30\text{ V}$ ; $I_B = 0\text{ A}$   | -   | -    | -1   | $\mu\text{A}$ |
|              |                                      | $V_{CE} = -30\text{ V}$ ; $I_B = 0\text{ A}$ ;<br>$T_j = 150\text{ }^{\circ}\text{C}$        | -   | -    | -5   | $\mu\text{A}$ |
| $I_{EBO}$    | emitter-base cut-off current         | $V_{EB} = -5\text{ V}$ ; $I_C = 0\text{ A}$  | -   | -    | -90  | $\mu\text{A}$ |
| $h_{FE}$     | DC current gain                      | $V_{CE} = -5\text{ V}$ ; $I_C = -5\text{ mA}$  | 80  | -    | -    |               |
| $V_{CEsat}$  | collector-emitter saturation voltage | $I_C = -10\text{ mA}$ ; $I_B = -0.5\text{ mA}$   | -   | -    | -150 | mV            |
| $V_{I(off)}$ | off-state input voltage              | $V_{CE} = -5\text{ V}$ ; $I_C = -100\text{ }\mu\text{A}$                                     | -   | -1.2 | -0.8 | V             |
| $V_{I(on)}$  | on-state input voltage               | $V_{CE} = -0.3\text{ V}$ ; $I_C = -2\text{ mA}$  | -3  | -1.6 | -    | V             |
| R1           | bias resistor 1 (input)              |  | 33  | 47   | 61   | k $\Omega$    |
| R2/R1        | bias resistor ratio                  |  | 0.8 | 1    | 1.2  |               |
| $C_c$        | collector capacitance                | $V_{CB} = -10\text{ V}$ ; $I_E = i_e = 0\text{ A}$ ;<br>$f = 1\text{ MHz}$                   | -   | -    | 3    | pF            |
| $f_T$        | transition frequency                 | $V_{CE} = -5\text{ V}$ ; $I_C = -10\text{ mA}$ ; <a href="#">[1]</a><br>$f = 100\text{ MHz}$ | -   | 180  | -    | MHz           |

[1] Characteristics of built-in transistor



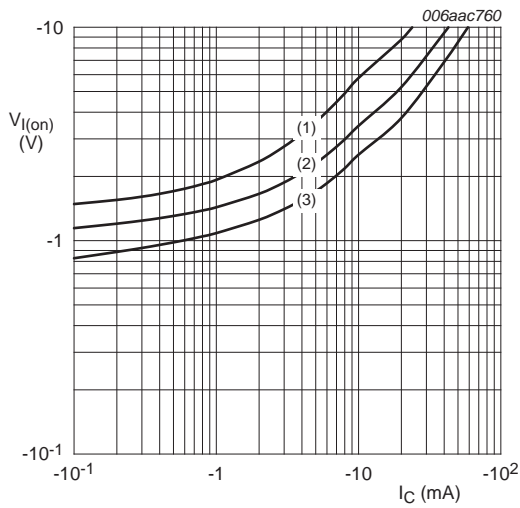
$V_{CE} = -5 \text{ V}$   
 (1)  $T_{amb} = 100 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = -40 \text{ }^\circ\text{C}$

**Fig 6. DC current gain as a function of collector current; typical values**



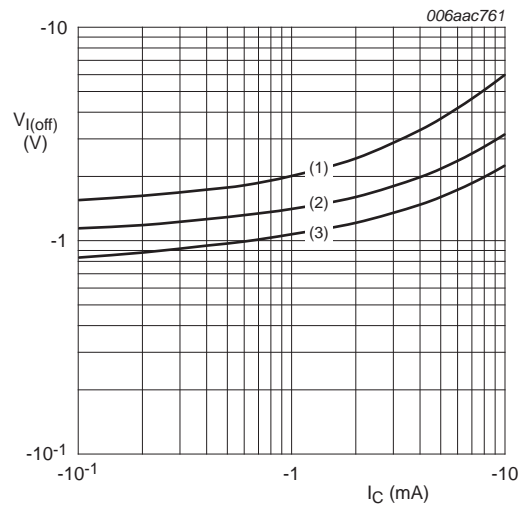
$I_C/I_B = 20$   
 (1)  $T_{amb} = 100 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = -40 \text{ }^\circ\text{C}$

**Fig 7. Collector-emitter saturation voltage as a function of collector current; typical values**



$V_{CE} = -0.3 \text{ V}$   
 (1)  $T_{amb} = -40 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = 100 \text{ }^\circ\text{C}$

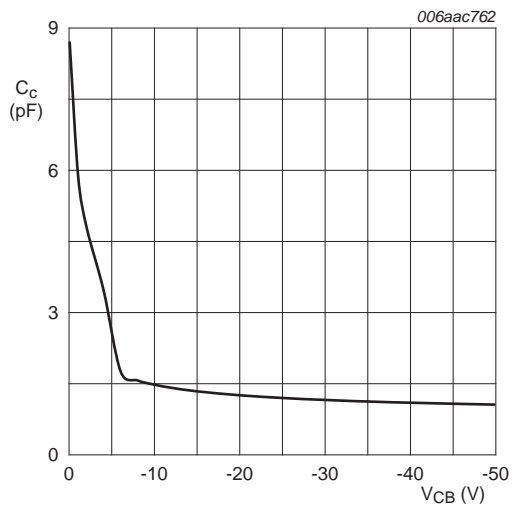
**Fig 8. On-state input voltage as a function of collector current; typical values**



$V_{CE} = -5 \text{ V}$   
 (1)  $T_{amb} = -40 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = 100 \text{ }^\circ\text{C}$

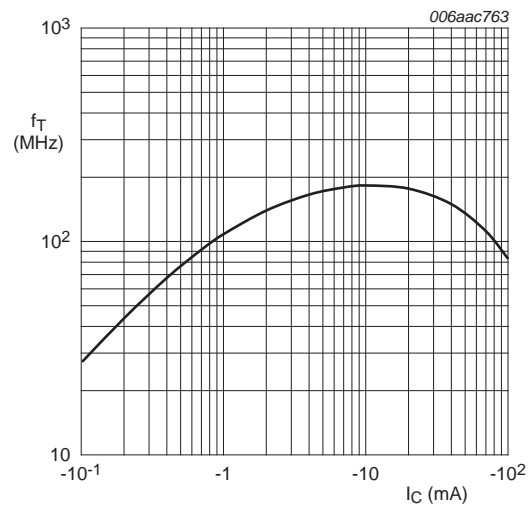
**Fig 9. Off-state input voltage as a function of collector current; typical values**





$f = 1 \text{ MHz}$ ;  $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

**Fig 10.** Collector capacitance as a function of collector-base voltage; typical values of built-in transistor



$V_{CE} = -5 \text{ V}$ ;  $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

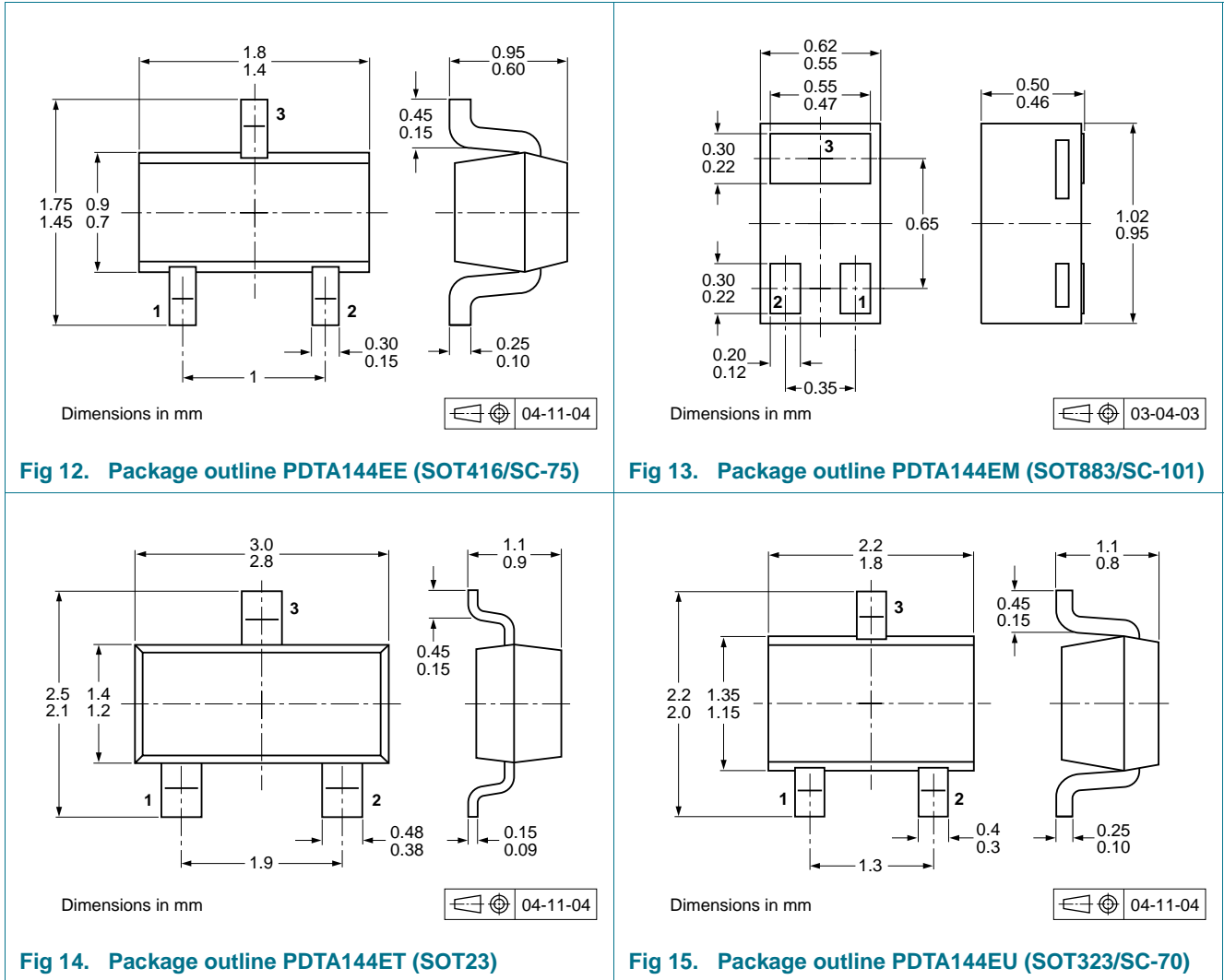
**Fig 11.** Transition frequency as a function of collector current; typical values of built-in transistor

## 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

**9. Package outline**



**10. Packing information**

**Table 9. Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

| Type number | Package | Description                    | Packing quantity |      |       |
|-------------|---------|--------------------------------|------------------|------|-------|
|             |         |                                | 3000             | 5000 | 10000 |
| PDTA144EE   | SOT416  | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |
| PDTA144EM   | SOT883  | 2 mm pitch, 8 mm tape and reel | -                | -    | -315  |
| PDTA144ET   | SOT23   | 4 mm pitch, 8 mm tape and reel | -215             | -    | -235  |
| PDTA144EU   | SOT323  | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |

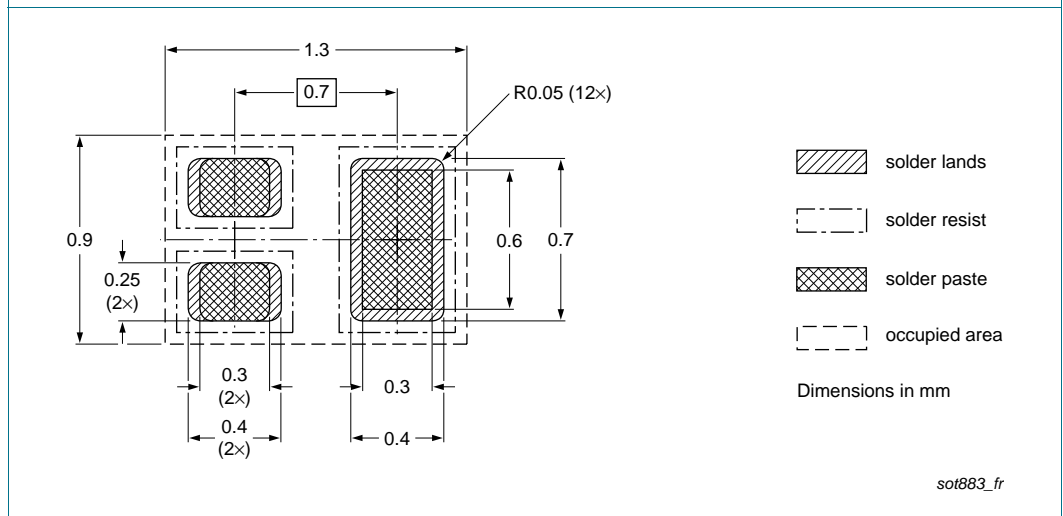
[1] For further information and the availability of packing methods, see [Section 14](#).

**11. Soldering**



Reflow soldering is the only recommended soldering method.

**Fig 16. Reflow soldering footprint PDTA144EE (SOT416/SC-75)**

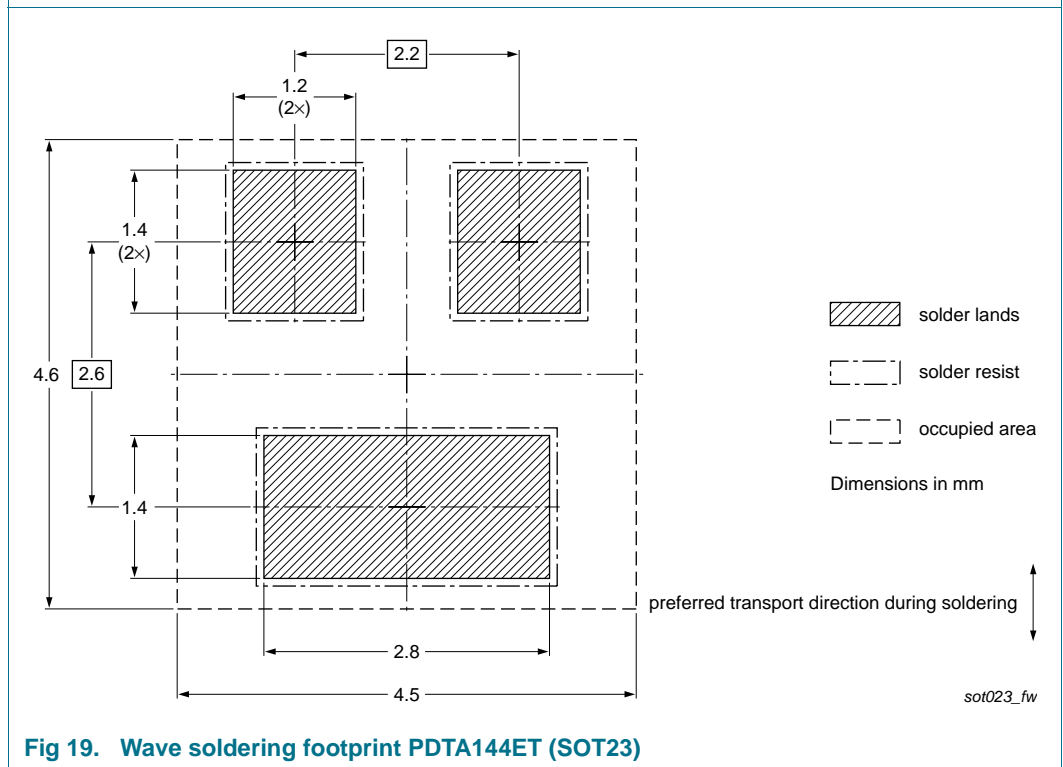


Reflow soldering is the only recommended soldering method.

**Fig 17. Reflow soldering footprint PDTA144EM (SOT883/SC-101)**



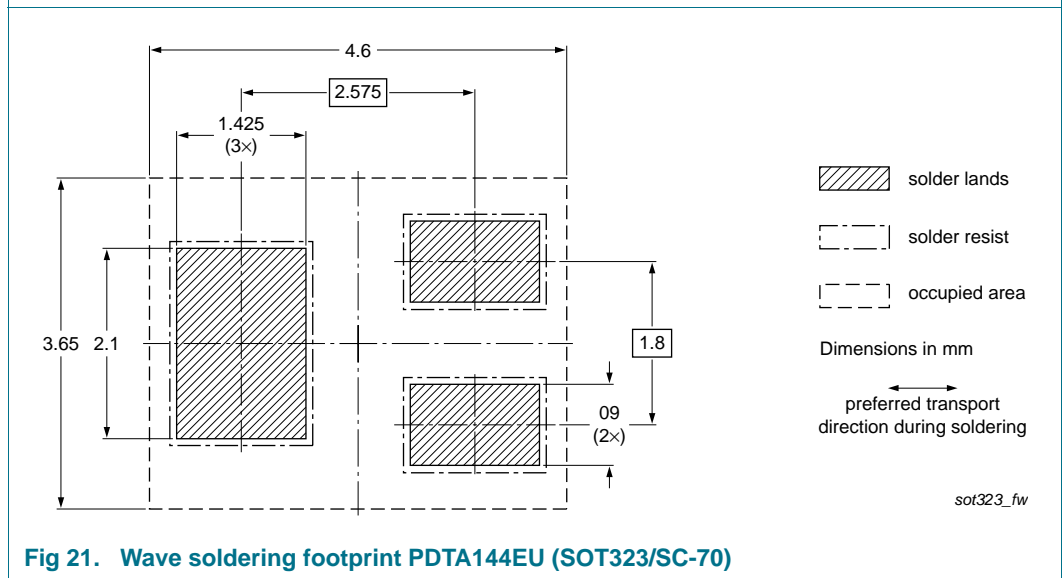
**Fig 18. Reflow soldering footprint PDTA144ET (SOT23)**



**Fig 19. Wave soldering footprint PDTA144ET (SOT23)**



**Fig 20. Reflow soldering footprint PDTA144EU (SOT323/SC-70)**



**Fig 21. Wave soldering footprint PDTA144EU (SOT323/SC-70)**

## 12. Revision history

Table 10. Revision history

| Document ID         | Release date  | Data sheet status     | Change notice | Supersedes          |
|---------------------|---|-----------------------|---------------|---------------------|
| PDTA144E_SERIES v.8 | 20111114  | Product data sheet    | -             | PDTA144E_SERIES v.7 |
| Modifications:      | <ul style="list-style-type: none"> <li>• The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>• Legal texts have been adapted to the new company name where appropriate.</li> <li>• Type numbers PDTA144EEF, PDTA144EK and PDTA144ES removed.</li> <li>• <a href="#">Section 1 "Product profile"</a>: updated</li> <li>• <a href="#">Section 3 "Ordering information"</a>: added</li> <li>• <a href="#">Section 4 "Marking"</a>: updated</li> <li>• <a href="#">Figure 1</a> to <a href="#">11</a>: added</li> <li>• <a href="#">Section 6 "Thermal characteristics"</a>: updated</li> <li>• <a href="#">Table 8 "Characteristics"</a>: <math>V_{i(on)}</math> redefined to <math>V_{I(on)}</math> on-state input voltage, <math>V_{i(off)}</math> redefined to <math>V_{I(off)}</math> off-state input voltage, <math>I_{CEO}</math> updated, <math>f_T</math> added</li> <li>• <a href="#">Section 8 "Test information"</a>: added</li> <li>• <a href="#">Section 9 "Package outline"</a>: superseded by minimized package outline drawings</li> <li>• <a href="#">Section 10 "Packing information"</a>: added</li> <li>• <a href="#">Section 11 "Soldering"</a>: added</li> <li>• <a href="#">Section 13 "Legal information"</a>: updated</li> </ul> |                       |               |                     |
| PDTA144E_SERIES v.7 | 20040805  | Product data sheet    | -             | PDTA144E_SERIES v.6 |
| PDTA144E_SERIES v.6 | 20030410  | Product specification | -             | -                   |

## 13. Legal information

### 13.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

## 13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 14. Contact information

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For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)



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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».



## JONHON

«**JONHON**» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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